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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



1725

Applicant: Krishna Seshan et al.

A WIRE-BONDABLE PROCESS FLOW COMPATIBLE WITH CU-M6

Docket No.: 884.659US1

Serial No.: 10/052089

Filed: January 16, 2002

Due Date: November 19, 2003

Examiner: Kiley Stoner

Group Art Unit: 1725

Customer No.: 21186

Confirmation No.: 9871

MS Non-Fee Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

A return postcard.

An Amendment and Response Under 37 C.F.R. 1.111 (8 Pages).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

By: Ann McCrackin

Atty: Ann M. McCrackin

Reg. No. 42,858

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 20th day of October, 2003.

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Signature

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(GENERAL)

OCT 23 2003
U.S. PATENT & TRADEMARK OFFICE
S/N 10/052089

PATENT

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Applicant: Krishna Seshan et al. Examiner: Kiley Stoner
Serial No.: 10/052089 Group Art Unit: 1725
Filed: January 16, 2002 Docket No.: 884.659US1
Title: A WIRE-BONDABLE PROCESS FLOW COMPATIBLE WITH CU-M6
Assignee: Intel Corporation Customer No.: 21186

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AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

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Alexandria, VA 22313-1450

Applicant has reviewed the Office Action mailed on August 19, 2003. Please amend the above-identified patent application as follows.